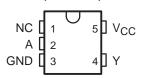
- EPIC<sup>™</sup> (Enhanced-Performance Implanted CMOS) Process
- Inputs Are TTL-Voltage Compatible
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- Package Options Include Plastic Small-Outline Transistor (DBV, DCK) Packages

#### DBV OR DCK PACKAGE (TOP VIEW)



NC - No internal connection

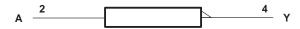
### description

The SN74AHCT1G04 contains one gate. The device performs the Boolean function  $Y = \overline{A}$ . The SN74AHCT1G04 is characterized for operation from  $-40^{\circ}$ C to  $85^{\circ}$ C.

#### **FUNCTION TABLE**

INPUT A	OUTPUT Y
Н	L
L	Н

## logic symbol†



<sup>&</sup>lt;sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

### logic diagram (positive logic)





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SCLS319J - MARCH 1996 - REVISED JANUARY 2000

# absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V <sub>CC</sub>	0.5 V to 7 V
Input voltage range, V <sub>I</sub> (see Note 1)	0.5 V to 7 V
Output voltage range, VO (see Note 1)	0.5 V to $V_{CC}$ + 0.5 V
Input clamp current, $I_{IK}$ ( $V_I < 0$ )	–20 mA
Output clamp current, I <sub>OK</sub> (V <sub>O</sub> < 0 or V <sub>O</sub> > V <sub>CC</sub> )	±20 mA
Continuous output current, $I_O(V_O = 0 \text{ to } V_{CC})$	±25 mA
Continuous current through V <sub>CC</sub> or GND	±50 mA
Package thermal impedance, $\theta_{JA}$ (see Note 2): DBV package	347°C/W
DCK package	389°C/W
Storage temperature range, T <sub>stq</sub>	–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

### recommended operating conditions

		MIN	MAX	UNIT
VCC	Supply voltage	4.5	5.5	V
VIH	High-level input voltage	2		V
VIL	Low-level input voltage		0.8	V
VI	Input voltage	0	5.5	V
VO	Output voltage	0	VCC	V
IOH	High-level output current		-8	mA
loL	Low-level output current		8	mA
Δt/Δν	Input transition rise or fall rate		20	ns/V
TA	Operating free-air temperature	-40	85	°C

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	vcc	T <sub>A</sub> = 25°C			MIN	MAX	UNIT
	TEST CONDITIONS		MIN	TYP	MAX	IVIIN	WAX	UNII
Vou	$I_{OH} = -50 \mu A$	4.5 V	4.4	4.5		4.4		V
VOH	$I_{OH} = -8 \text{ mA}$		3.94			3.8		
V <sub>OL</sub>	I <sub>OL</sub> = 50 μA	4.5 V			0.1		0.1	V
	$I_{OL} = 8 \text{ mA}$	4.5 V			0.36		0.44	v
lį	$V_I = V_{CC}$ or GND	0 V to 5.5 V			±0.1		±1	μΑ
ICC	$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V			1		10	μΑ
∆lCC <sup>‡</sup>	One input at 3.4 V, Other inputs at V <sub>CC</sub> or GND	5.5 V			1.35		1.5	mA
C <sub>i</sub>	$V_I = V_{CC}$ or GND	5 V		4	10		10	pF

 $<sup>\</sup>ddagger$  This is the increase in supply current for each input at one of the specified TTL voltage levels rather than 0 V or V<sub>CC</sub>.



NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

<sup>2.</sup> The package thermal impedance is calculated in accordance with JESD 51.

SCLS319J - MARCH 1996 - REVISED JANUARY 2000

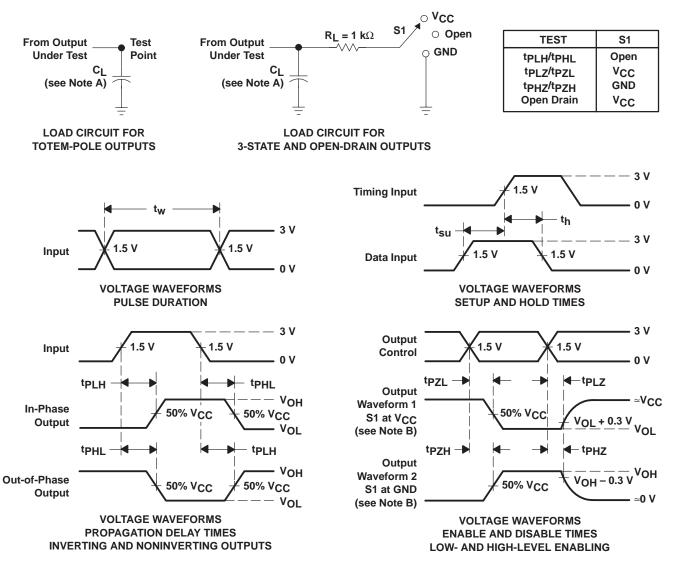
# switching characteristics over recommended operating free-air temperature range, $V_{CC}=5~V\pm0.5~V$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM TO (OUTPUT)	то	LOAD CAPACITANCE	T <sub>A</sub> = 25°C			MIN	MAX	UNIT		
		(OUTPUT)		MIN	TYP	MAX	IVIIIN	IVIAA	UNIT		
t <sub>PLH</sub>	Λ	Y	V	V C. – 15 pc	A V C. 45 pF		4.7	6.7	1	7.5	no
t <sub>PHL</sub>	A		C <sub>L</sub> = 15 pF		4.7	6.7	1	7.5	ns		
t <sub>PLH</sub>	Δ.	A Y	C: _ 50 pE		5.5	7.7	1	8.5	20		
t <sub>PHL</sub>	Α		ı	'		C <sub>L</sub> = 50 pF		5.5	7.7	1	8.5

# operating characteristics, $V_{CC}$ = 5 V, $T_A$ = 25°C

PARAMETER		TEST C	ONDITIONS	TYP	UNIT
C <sub>pd</sub>	Power dissipation capacitance	No load,	f = 1 MHz	14	pF

#### PARAMETER MEASUREMENT INFORMATION



NOTES: A. C<sub>I</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz,  $Z_O = 50 \Omega$ ,  $t_\Gamma \leq 3$  ns,  $t_f \leq 3$  ns.
- D. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



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